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PATENTS ONLY

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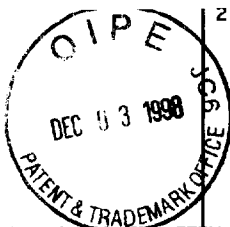


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PATENTS ONLY

AND TRADEMARKS
t or copy thereof

1. Name of conveying party(ies):
Hisao NAKANISHI



2. Name and Address of receiving party(ies):

Name: SUMITOMO BAKELITE COMPANY LIMITED

Address: 5-8, Higashishinagawa - 2-chome
Shinagawa-ku, Tokyo, JAPAN

Additional name(s) of conveying party(ies) attached? [] Yes [XX] No

Additional name(s) & address(es) attached? [] Yes [XX] No

3. Nature of conveyance:

☒ Assignment

[] Change of Name

[] Other

[] Security Agreement

[] Merger

Execution Date: April 27, 1998

4. Application number(s) or patent number(s). If this document is being filed together with a new application, the execution date of the application is: _____

Date

A. Patent Application No.(s)

B. Patent No.(s)

09/068,968

Additional numbers attached? [] Yes [X] No

5. Name and address of party to whom correspondence concerning document should be mailed:

BROUDY AND WEIMARK, P.L.L.C.
419 Seventh Street, N.W.
Suite 300
Washington D.C. 20004

6. Number of applications and patents involved:
(1)

7. Amount of fee enclosed or authorized to be charged: **\$40.00**

8. Check no. 20701 in the amount of \$40.00 is attached.

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9. Statement and Signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Norman J. Latker (Reg. No. 19,963)

Name of Person Signing

Signature

12/3/98

Date

12/07/1998 DNGUYEN 00000308 09068968

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Total number of pages comprising cover sheet [01]

PATENT
REEL: 9617 FRAME: 0447

Sole Inventor

ASSIGNMENT

IN CONSIDERATION of the sum of One Dollar(\$1.00) or the equivalent thereof, and other good and valuable consideration paid to Hisao NAKANISHI,

a citizen of Japan by SUMITOMO BAKELITE COMPANY LIMITED, a corporation organized under the laws of Japan,

located at 5-8, Higashishinagawa-2-chome, Shinagawa-ku, Tokyo, Japan,

receipt of which is hereby acknowledged, I, the said Hisao NAKANISHI,

do hereby sell and assign to said SUMITOMO BAKELITE COMPANY LIMITED,

~~thxix~~ its successors and assigns, all my right, title and interest, in and for the United States of America, in and to "COVER TAPE FOR PACKAGING ELECTRONIC COMPONENTS"

invented by me and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, reissues, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said SUMITOMO BAKELITE COMPANY LIMITED,

~~thxix~~ its Successors, assigns or other legal representatives, to the full end of the term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of said above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said SUMITOMO BAKELITE COMPANY LIMITED.

Signed this 27th day of April, 1998.

Hisao Nakanishi
(Hisao NAKANISHI)

WITNESS:

S. Nakatani

WITNESS:

S. Yamamoto